TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74HC259AFN

#### 8-Bit Addressable Latch

The TC74HC259A is a high speed CMOS ADDRESSABLE LATCH fabricated with silicon gate C<sup>2</sup>MOS technology.

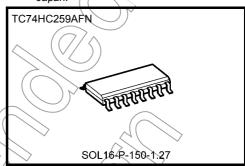
It achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The respective bits are controlled by address inputs A, B, and C. When  $\overline{\text{CLEAR}}$  input is held high and enable input G is held low, the data is written into the bit selected by address inputs, the other bit hold their previous conditions.

When both  $\overline{\text{CLEAR}}$  and  $\overline{\text{G}}$  held high, writing of all bits is inhibited regardless of adress inputs, and their previous condition are held. When  $\overline{\text{CLEAR}}$  is held low and  $\overline{\text{G}}$  is held high, all bits are resent to low regardless of the other inputs. When both of  $\overline{\text{CLEAR}}$  and  $\overline{\text{G}}$  held low, all bits which isn't selected by adress inputs are resent to low.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.



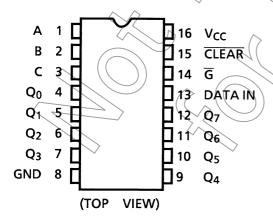


Weight 0.13 g (typ.)

#### **Features**

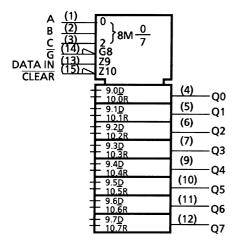
- High speed:  $t_{pd} = 15 \text{ ns}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation: ICC =  $4 \mu A \text{ (max)}$  at Ta = 25 °C
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | IOH | = IOL = 4 mA (min)
- Balanced propagation delays: tpLH≈tpHL
- Wide operating voltage range: Vec (opr) = 2~6 V
- Pin and function compatible with 74LS259

### **Pin Assignment**



2012-02-29

# **IEC Logic Symbol**



#### **Truth Table**

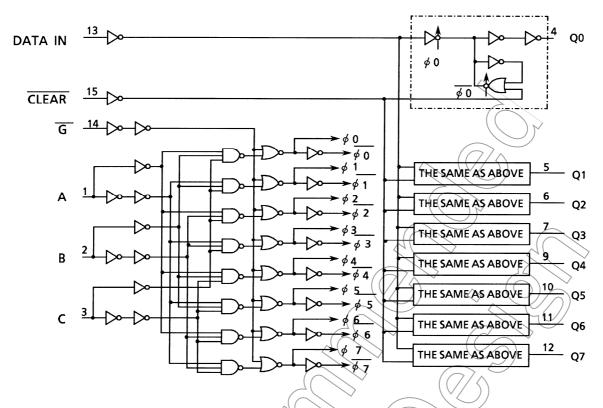
Input	s	Output of Addressed	Each Other	Function
CLEAR	G	Latch	Output	1 diletion
Н	L	D	QiO	Addressable Latch
Н	Н	QiO	QiO	Memory
L	L	D	L	8-Line Demultriplexer
L	Н	L	L	Clear All Bits to "L"

Se	lect Inpu	uts	Latch Addressed				
С	В	Α	Laterraduressed				
L	L	L	Q0 ((				
L	L	Н	Q1				
L	Н	L	Q2 (7/\s\)				
L	Н	Н	Q3 V				
Н	L	L «	Q4				
Н	L	Н	Q5				
Н	Н	L	Q6				
Н	Н	(H/)	Q7				
•		(^					

D: The level at the data input.

QiO: The level before the indicared steady-state input conditions were established (i = 0, 1, .... 7)

#### **System Diagram**



### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	ACC	-0.5~7.0	V
DC input voltage	VIN	-0.5~V <sub>CC</sub> + 0.5	٧
DC output voltage	<b>У</b> ОПТ	-0.5-V <sub>CC</sub> + 0.5	V
Input diode current	//ik	±20	mA
Output diode current	I <sub>OK</sub>	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	P <sub>D</sub>	180	mW
Storage temperature	Tstg	-65~150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

3

# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2~6	V
Input voltage	V <sub>IN</sub>	0~V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0~V <sub>CC</sub>	⟨ v
Operating temperature	T <sub>opr</sub>	−40 <b>~</b> 85	S
		0~1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	$t_r$ , $t_f$	0~500 (V <sub>CC</sub> = 4.5 V)	ns
		0~400 (V <sub>CC</sub> = 6.0 V)	())

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

### **Electrical Characteristics**

#### **DC Characteristics**

		Test Condition	1	٠ (ر	Ta = 25°C	:/	Ta ≠ -4	0~85°C	
Characteristics	Symbol		VC6 (V)	Min	Тур	Max	Min	Max	Unit
			2.0	1.50	_	$(\mathcal{I})$	1.50	_	
High-level input voltage	V <sub>IH</sub>	-	4.5	3.15	7/1		3.15	_	V
			6.0	4.20	$(\checkmark)$	) —	4.20		
			2.0/		1	0.50	_	0.50	
Low-level input voltage	V <sub>IL</sub>		4.5	_	) )—	1.35	_	1.35	V
, and the second			6.0		/-	1.80	—	1.80	
			2.0	1.9	2.0	_	1.9	_	
	Voн	V <sub>IN</sub>   I <sub>OH</sub> = -20 μA	4.5	4.4	4.5	_	4.4	_	
High-level output voltage		=V <sub>IH</sub> or	6.0	5.9	6.0	_	5.9	_	V
		V <sub>IL</sub> I <sub>OH</sub> = -4 mA	4.5	4.18	4.31	_	4.13	_	
	// ) \_	I <sub>OH</sub> = -5.2 mA	6.0	5.68	5.80	_	5.63	_	
			2.0	_	0.0	0.1	_	0.1	
		V <sub>IN</sub>	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	VoL	= V <sub>IH</sub> or	6.0	_	0.0	0.1	_	0.1	V
		V <sub>IL</sub>	4.5	_	0.17	0.26	_	0.33	
		I <sub>OL</sub> = 5.2 mA	6.0	_	0.18	0.26	_	0.33	
Input leakage current	)) I <sub>IN</sub>	V <sub>IN</sub> =V <sub>CC</sub> or GND	6.0	_	_	±0.1	_	±1.0	μΑ
Quiescent supply current	lco	VIN VCC or GND	6.0	_	_	4.0		40.0	μΑ



# Timing Requirements (input: $t_r = t_f = 6$ ns)

Characteristics	Characteristics Symbol		Test Condition			Ta = -40 ~85°C	Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width			2.0	_	75	95	
(G)	t <sub>W (L)</sub>	_	4.5 〈	_	15	19	ns
(0)			6.0	$\geq$	13	16	
Minimum pulse width			2.0	$(\leftarrow)$	75	95	
(CLEAR)	t <sub>W (L)</sub>	_	4.5		15	19	ns
(OLL/IIV)		<	6.0	<b>(</b> <del>))</del>	13	16	
Minimum set-up time			2.0		50	60	
(DATA)	ts	_	(4.5)	· —	10	12	ns
,			6.0	_	9	11	
Minimum set-up time		4	2.0	_	25	30	
(A, B, C)	t <sub>S</sub>	-	√ 4.5	- (	5	6	ns
, , ,		$(\sqrt{2})$	6.0	+(	))5	5	
Minimum hold time			2.0	(7)	(25)	/ 30	
(DATA)	t <sub>h</sub>		4.5	7	5	6	ns
		4()	6.0	$(\mathcal{I})$	5	5	
Minimum hold time			2.0		0	0	
(A, B, C)	t <sub>h</sub>		4.5	) —	0	0	ns
l' '		4( > /	6.0	_	0	0	

# AC Characteristics ( $C_L = 15 \text{ pF}$ , $V_{CC} = 5 \text{ V}$ , $Ta = 25 ^{\circ}\text{C}$ , input: $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	TTEH /TTEH		_	4	8	ns
Propagation delay time	tpLH		_	15	22	ns
(DATA-Q)	→ t <sub>pHL</sub> 〈					
Propagation delay time	t <sub>pLH</sub>			21	32	ns
(A, B, C-Q)	t <sub>pHL</sub>			21	32	113
Propagation delay time	t <sub>pLH</sub>			16	28	no
( <del>G</del> -Q)	tpĤ⊵	_		10	20	ns
Propagation delay time (CLEAR-Q)	tpHL	_	_	13	23	ns

AC Characteristics (CL = 50 pF, input:  $t_r = t_f = 6 \text{ ns}$ )

		Test Condition		Ta = 25°C			Ta = -4	Ta = -40~85°C	
Characteristics	Symbol		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Unit
	<b>4</b>		2.0	_	30	75	_	95	
Output transition time	t <sub>TLH</sub>	_	4.5	_	8	15	_	19	ns
	t <sub>THL</sub>		6.0	_	7	13	_	16	
Propagation delay	t-111		2.0	_	56	130	\ <u></u>	165	
time	t <sub>pLH</sub>	_	4.5	_	18	26	) —	33	ns
(DATA-Q)	t <sub>pHL</sub>		6.0	_<	15	22	_	28	
Propagation delay	<b>+</b>		2.0	_/	83	185	_	230	
time	t <sub>pLH</sub>	_	4.5	-(	25	37	_	46	ns
(A, B, C-Q)	$t_{pHL}$		6.0	_/	21)	31	_	39	
Propagation delay time	t <sub>pLH</sub>		2.0		67	165		205	
(G-Q)	t <sub>pHL</sub>	_	4.5	1	20	33		41	ns
( G -Q)	Pric		6.0		17	28	7-/	> 35	
Propagation delay			2.0	<i>J</i>	52	135	(H)	170	
time	$t_{pHL}$	-	4.5	_	16	27		34	ns
(CLEAR -Q)			6.0	_	14	23	√	29	
Input capacitance	C <sub>IN</sub>	-	$\vee$	_	5	_10)	_	10	pF
Power dissipation	C <sub>PD</sub>		>	(	(35)	\			ηE
capacitance	(Note)				\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	<i></i>			pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

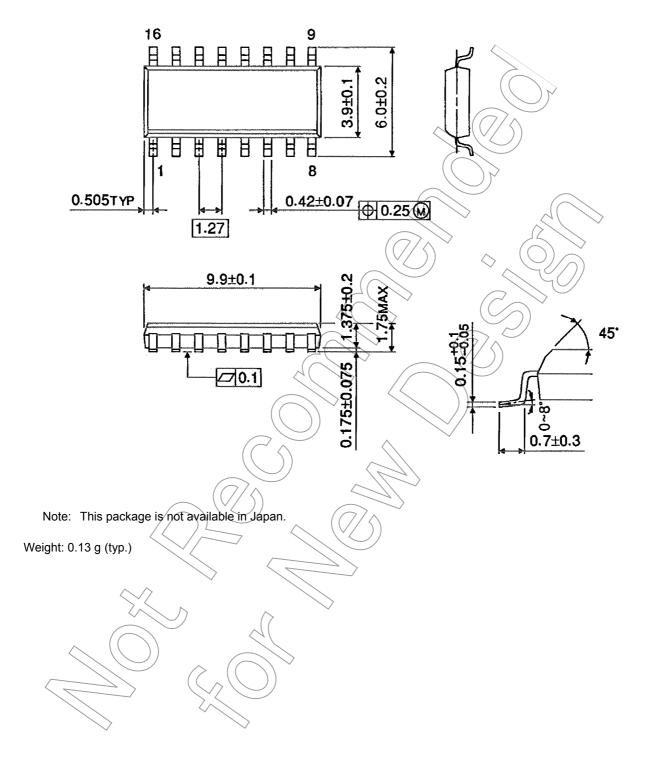
6





# **Package Dimensions (Note)**

SOL16-P-150-1.27 Unit: mm



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